

## General Description

The MY10N65F-B is silicon N-channel Enhanced VDMOSFETs, obtained by the self-aligned planar Technology which reduce the conduction loss, improve switching performance and enhance the avalanche energy.

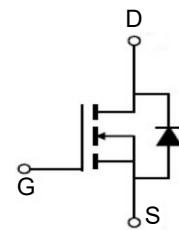


## Features

|  |     |   |
|--|-----|---|
| V <sub>DSS</sub>                               | 650 | V |
| I <sub>D</sub>                                 | 10  | A |
| P <sub>D</sub> ( T <sub>C</sub> = 25 °C)       | 48  | W |
| R <sub>DS(ON)</sub> (at V <sub>GS</sub> = 10V) | 0.6 | Ω |

## Application

- High efficiency switch mode power supplies
- Power factor correction
- Electronic lamp ballast



## Package Marking and Ordering Information

| Product ID | Pack    | Marking | Qty(PCS) |
|------------|---------|---------|----------|
| MY10N65F-B | TO-220F | 10N65   | 1000     |

## Absolute Maximum Ratings (T<sub>c</sub>=25 °C unless otherwise noted)

| Symbol           | Parameters                           | Ratings | Unit |
|------------------|--------------------------------------|---------|------|
| V <sub>DSS</sub> | Drain-Source Voltage                 | 650     | V    |
| V <sub>GS</sub>  | Gate-Source Voltage-Continuous       | ±30     | V    |
| I <sub>D</sub>   | Drain Current-Continuous (Note 2)    | 10      | A    |
| I <sub>DM</sub>  | Drain Current-Single Plused (Note 1) | 38      | A    |
| P <sub>D</sub>   | Power Dissipation (Note 2)           | 48      | W    |
| T <sub>j</sub>   | Max.Operating junction temperature   | 150     | °C/W |

**Electrical Characteristics ( $T_c=25^\circ\text{C}$ , unless otherwise noted)**

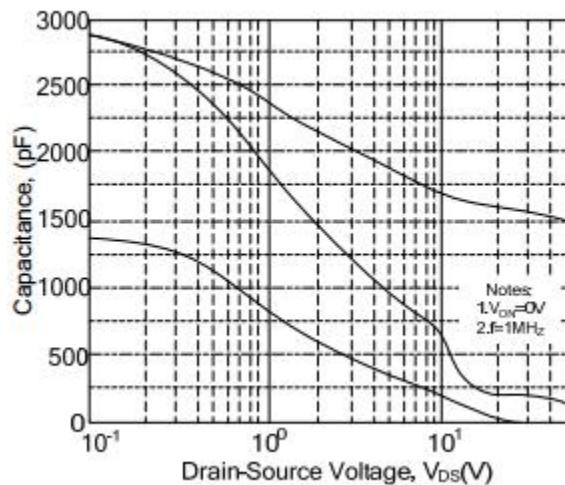
| Symbol                           | Parameters   | Min | Typ  | Max       | Units                     | Conditions   |
|----------------------------------|--|-----|------|-----------|---------------------------|--|
| <b>Static Characteristics</b>    |  |     |      |           |                           |  |
| $B_{VDSS}$                       | Drain-Source Breakdown VoltageCurrent (Note 1)         | 650 | --   | --        | mA                        | $I_D=250\mu\text{A}$<br>$V_{GS}=0\text{V}$ , $T_J=25^\circ\text{C}$  |
| $V_{GS(\text{th})}$              | Gate Threshold Voltage                                 | 2.0 | --   | 4.0       | V                         | $V_{DS}=V_{GS}$ , $I_D=250\mu\text{A}$                               |
| $R_{DS(\text{on})}$              | Drain-Source On-Resistance                             | --  | 0.6  | 0.8       | $\Omega$                  | $V_{GS}=10\text{V}$ , $I_D=5\text{A}$                                |
| $I_{GSS}$                        | Gate-Body Leakage Current                              | --  | --   | $\pm 100$ | nA                        | $V_{GS}=\pm 30\text{V}$ , $V_{DS}=0$                                 |
| $I_{DSS}$                        | Zero Gate Voltage Drain Current                        | --  | --   | 1         | $\mu\text{A}$             | $V_{DS}=650\text{V}$ , $V_{GS}=0$                                    |
| <b>Switching Characteristics</b> |  |     |      |           |                           |  |
| $T_{d(\text{on})}$               | Turn-On Delay Time                                     | --  | 23   | 55        | ns                        | $V_{DS}=325\text{V}$ , $I_D=10\text{A}$ ,<br>$R_G=25\Omega$ (Note 2) |
| $T_r$                            | Rise Time  | --  | 69   | 150       | ns                        |  |
| $T_{d(\text{off})}$              | Turn-Off Delay Time                                    | --  | 144  | 300       | ns                        |  |
| $T_f$                            | Fall Time  | --  | 77   | 165       | ns                        |  |
| $Q_g$                            | Total Gate Charge                                      | --  | 44   | 57        | nC                        | $V_{DS}=520$ , $V_{GS}=10\text{V}$ ,<br>$I_D=10\text{A}$ (Note 2)    |
| $Q_{gs}$                         | Gate-Source Charge                                     | --  | 6.7  | --        | nC                        |  |
| $Q_{gd}$                         | Gate-Drain Charge                                      | --  | 18.5 | --        | nC                        |  |
| <b>Dynamic Characteristics</b>   |  |     |      |           |                           |  |
| $C_{iss}$                        | Input Capacitance                                      | --  | 1570 | 2040      | pF                        | $V_{DS}=25\text{V}$ , $V_{GS}=0$ ,<br>$f=1\text{MHz}$                |
| $C_{oss}$                        | Output Capacitance                                     | --  | 166  | 215       | pF                        |  |
| $C_{rss}$                        | Reverse Transfer Capacitance                           | --  | 18   | 24        | pF                        |  |
| $I_s$                            | Continuous Drain-Source Diode Forward Current (Note 2) | --  | --   | 10        | A                         |  |
| $V_{SD}$                         | Diode Forward On-Voltage                               | --  | --   | 1.4       | V                         | $I_s=10\text{A}$ , $V_{GS}=0$  |
| $R_{th(j-c)}$                    | Thermal Resistance, Junction to Case                   | --  | --   | 0.85      | $^\circ\text{C}/\text{W}$ |  |

Note 1: Repetitive Rating : Pulse width limited by maximum junction temperature

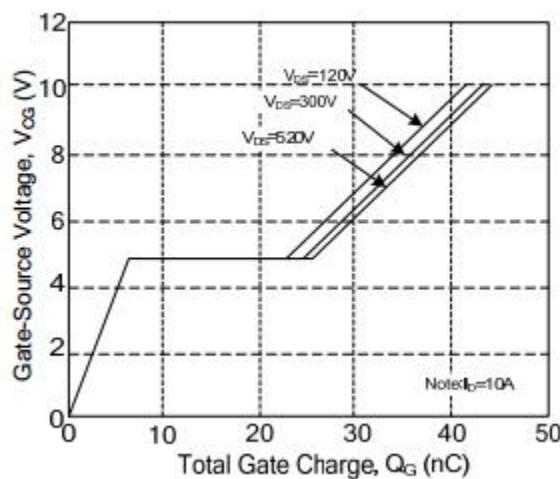
Note 2: Pulse test: PW <= 300us , duty cycle <= 2%.

## Ratings and Characteristic curves

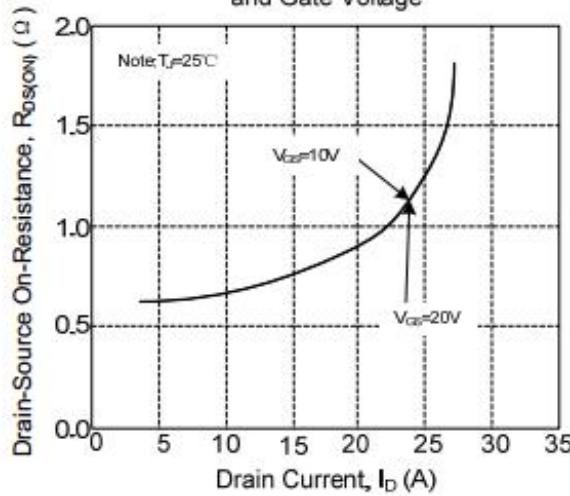
Capacitance Characteristics



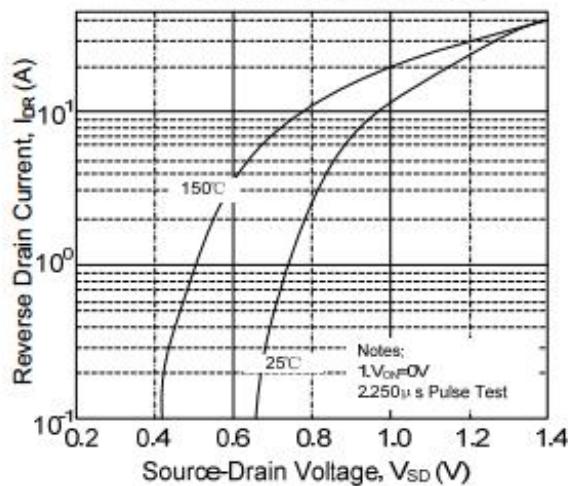
Gate Charge Characteristics



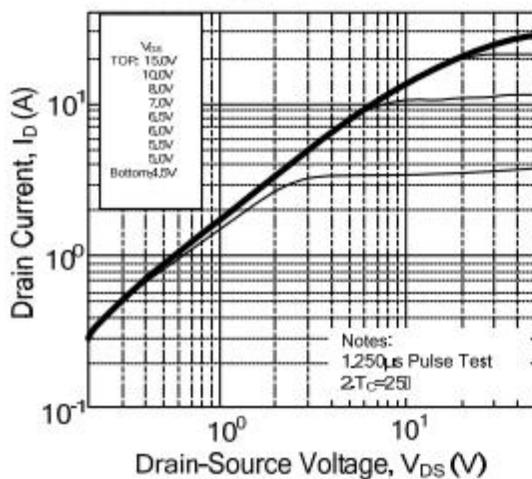
On-Resistance Variation vs. Drain Current and Gate Voltage



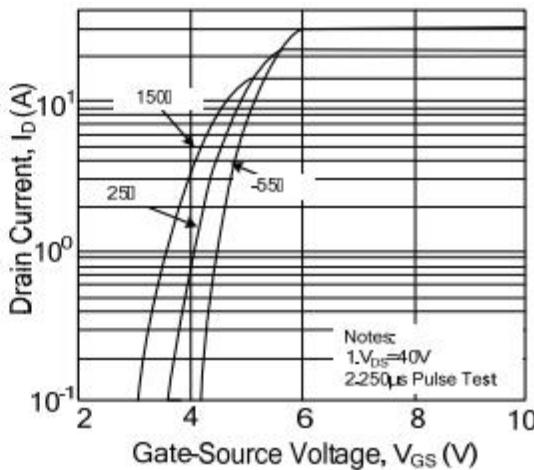
Body Diode Forward Voltage Variation with Source Current and Temperature



On-Region Characteristics



Transfer Characteristics



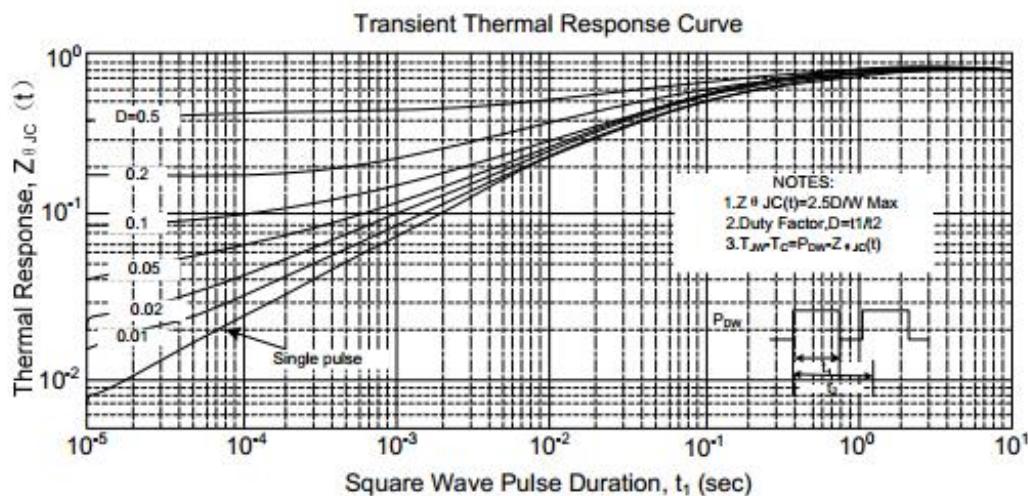
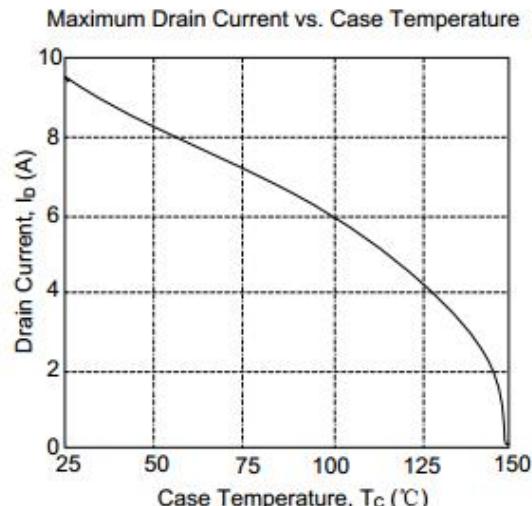
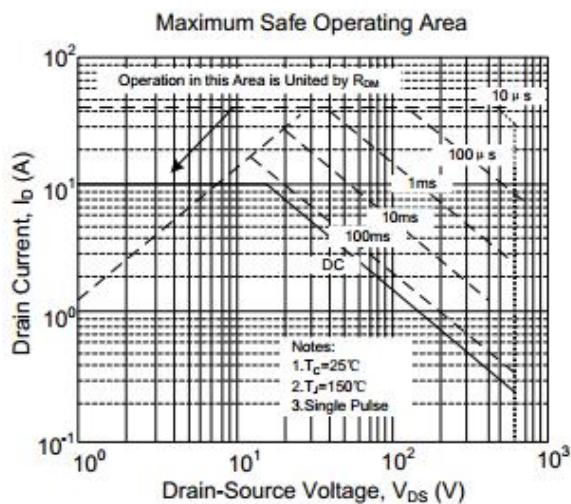
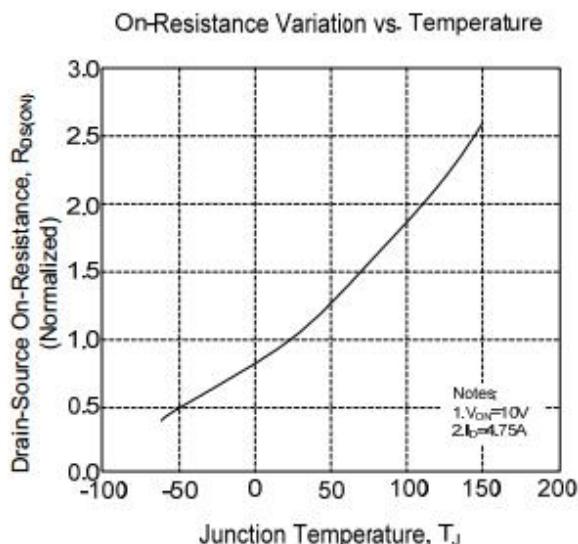
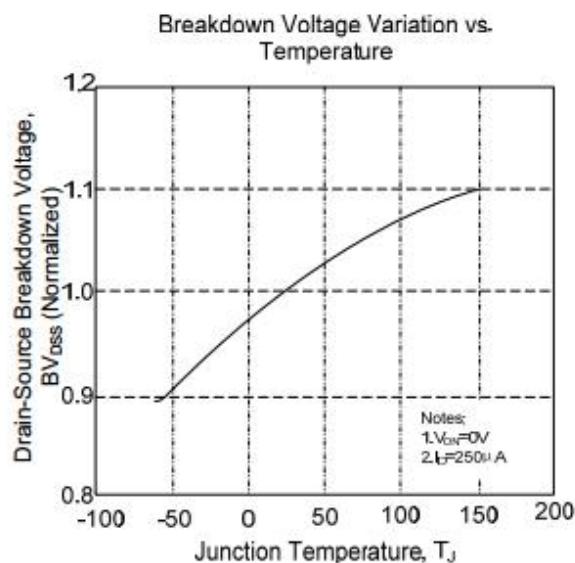


Fig 12. Gate Charge Test Circuit &amp; Waveform

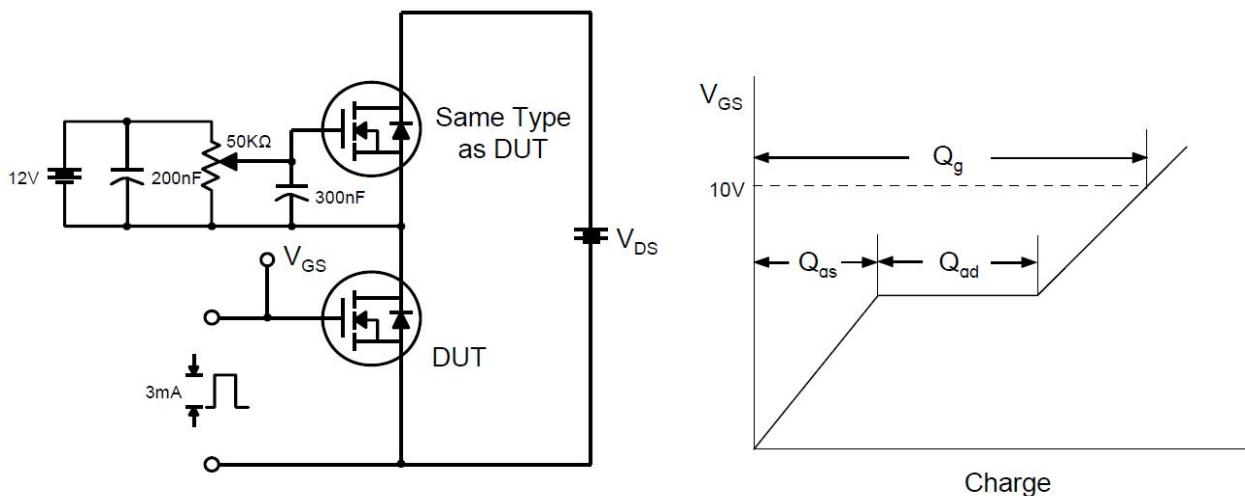


Fig 13. Resistive Switching Test Circuit &amp; Waveforms

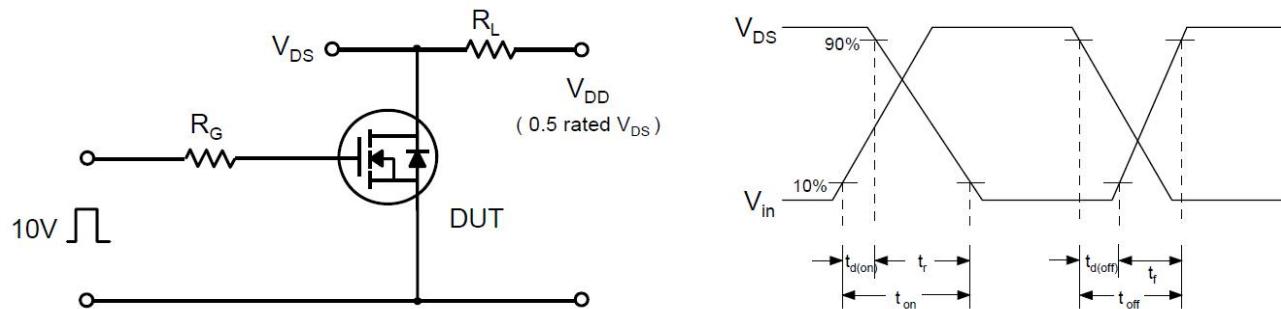


Fig 14. Unclamped Inductive Switching Test Circuit &amp; Waveforms

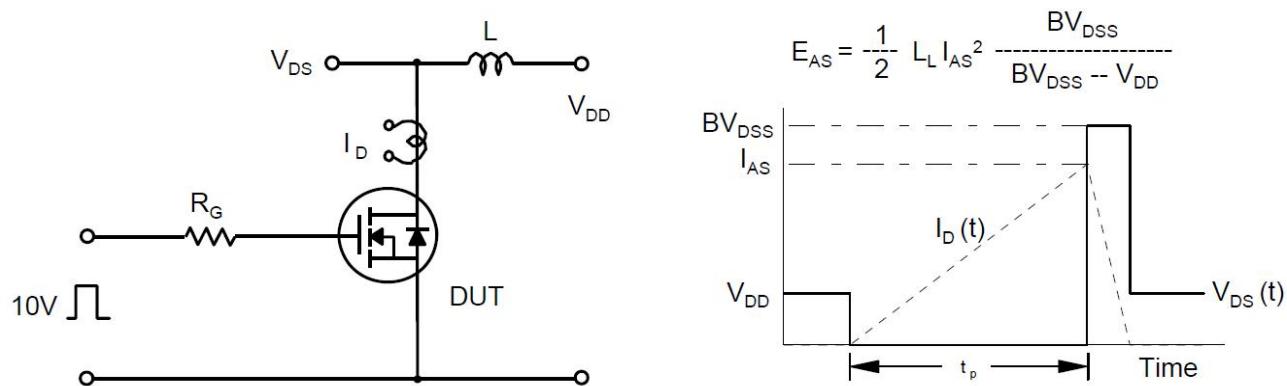
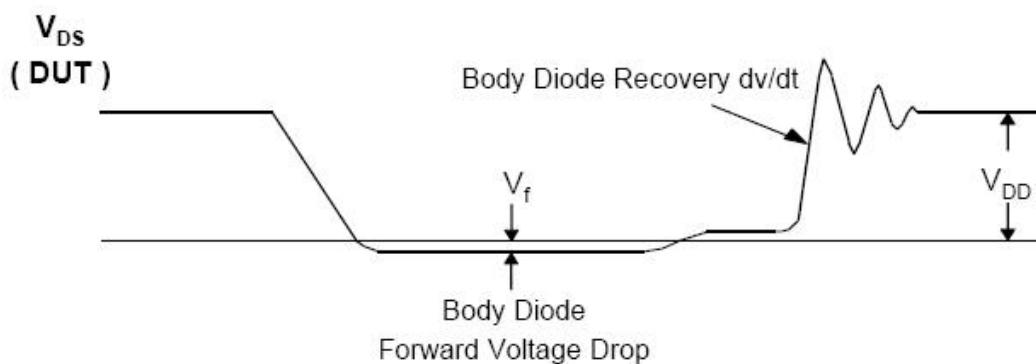
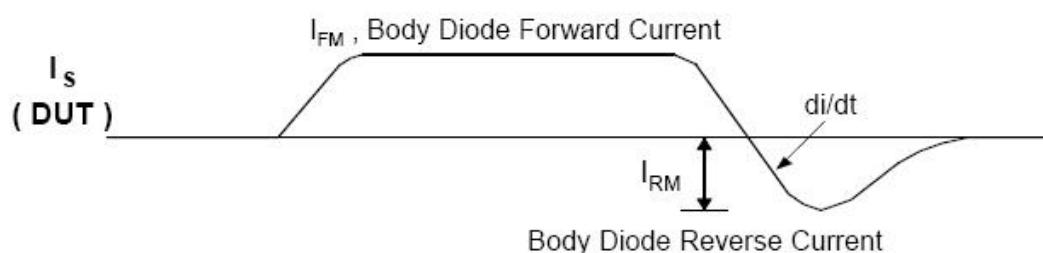
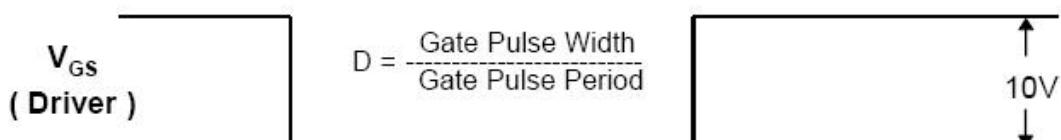
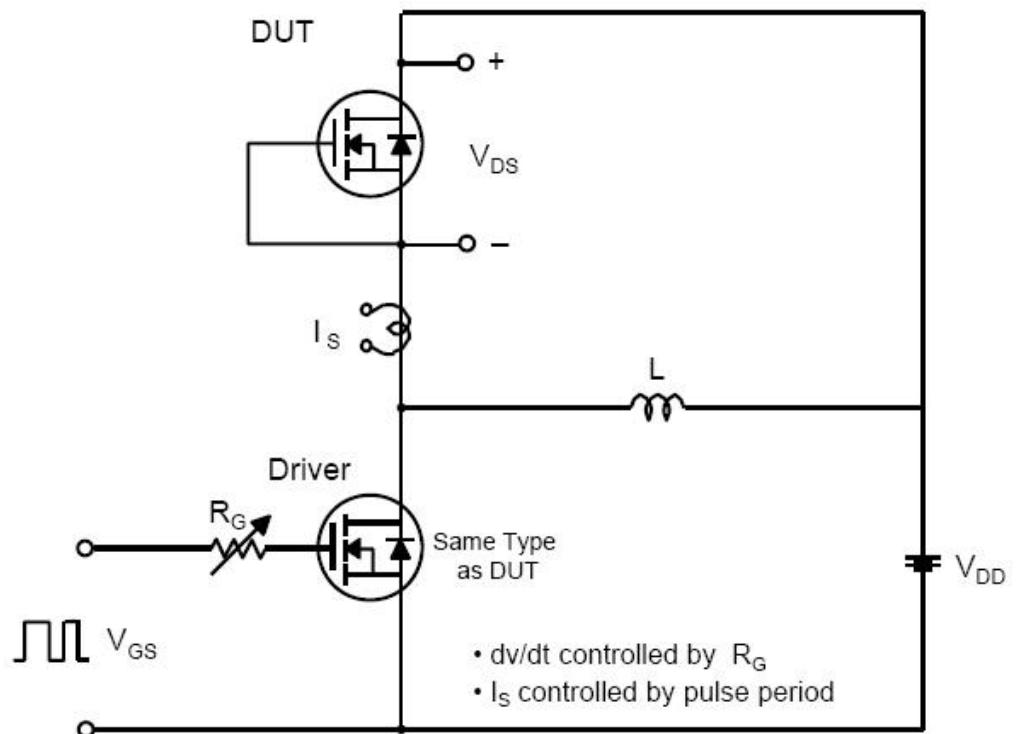
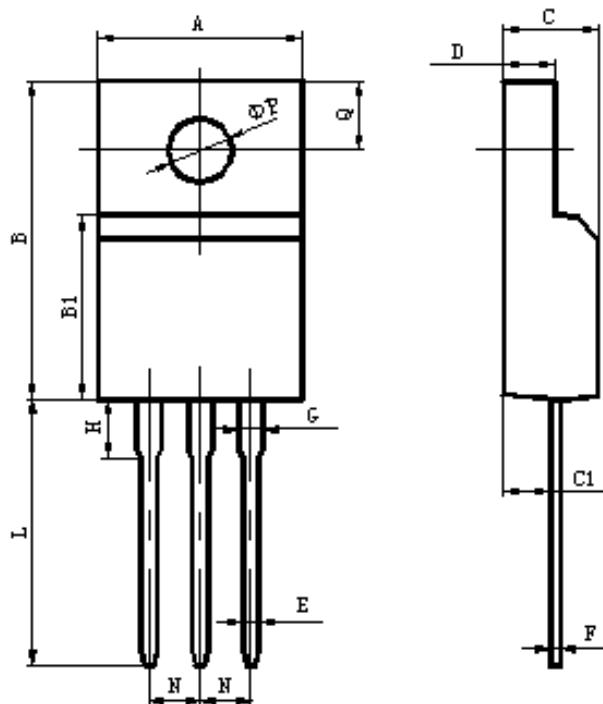


Fig 15. Peak Diode Recovery dv/dt Test Circuit &amp; Waveforms



**Package Mechanical Data-TO-220F Single**



| Items    | Values(mm) |      |
|----------|------------|------|
|          | MIN        | MAX  |
| A        | 9.60       | 10.4 |
| B        | 15.4       | 16.2 |
| B1       | 8.90       | 9.50 |
| C        | 4.30       | 4.90 |
| C1       | 2.10       | 3.00 |
| D        | 2.40       | 3.00 |
| E        | 0.60       | 1.00 |
| F        | 0.30       | 0.60 |
| G        | 1.12       | 1.42 |
| H        | 3.40       | 3.80 |
|          | 2.40       | 2.90 |
| L*       | 12.0       | 14.0 |
| N        | 2.34       | 2.74 |
| Q        | 3.15       | 3.55 |
| $\Phi P$ | 2.90       | 3.30 |